PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kenzo SAIKI	04/17/2008

RECEIVING PARTY DATA

Name:	IBIDEN CO., LTD.
Street Address:	1, Kandacho 2-Chome, Ogaki-Shi
City:	Gifu
State/Country:	JAPAN
Postal Code:	503-8604

PROPERTY NUMBERS Total: 1

Property Type	N	lumber
Application Number:	12106141	

CORRESPONDENCE DATA

Fax Number: (703)519-9958

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Correspondent Name: Masayasu Mori

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ATTORNEY DOCKET NUMBER: 01098_1102

NAME OF SUBMITTER: Masayasu Mori

Total Attachments: 2

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PATENT REEL: 020827 FRAME: 0427

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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I/we the undersigned, <u>KENZO SAIKI residing at Ogaki-Shi. Gifu. Japan.</u>, hereby sell, assign, and transfer to <u>IBIDEN CO., LTD.</u>, a corporation of <u>Japan</u>, having a principal place of business at <u>1. Kandacho 2-Chome. Ogaki-Shi. Gifu 503-8604</u>

<u>Japan</u> ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent, entitled:

	MAT MATERIAL AND EXI	HAUST GAS	TREATMENT DEVI	CE
which has	been executed by the undersigne			
☐ which was	filed on	_ and assigned	d Serial No.	

and in to said application and all divisional, continuing, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

agree that said Assignee may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all assignments and powers of attorney; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:					
	Kenzo Saiki				
April 17 ,2008					
Date	Name: KENZO SAIKI				